

## SOLDER CONNECTION

Email: sales@solderconnection.co.uk | Tel: +44(0)1291 624 400

### **Technical Bulletin**

### RMA 3% Rosin Cored Solder Wire



#### DESCRIPTION

RMA cored wire is a mildly activated, general-purpose wire solder for use in electronics soldering applications. RMA cored wire provides excellent tarnish and oxide removal producing shiny solder joints. RMA cored wire complies with MIL-F-14256 and QQ-S-571 specifications. RMA cored wire produces slight to moderate post-process residues that may be left on the substrate or removed with commercially available flux removers.

#### FEATURES AND BENEFITS

- Rosin Mildly Activated
- Promotes Thermal Transfer
- ROLO per J-STD-004B
- Glycol-Free
- Fast Wetting Properties

#### ALLOY AVAILABILITY

RMA cored wire is available in common alloys, diameters and spool sizes. Other alloys, diameters and spool sizes may be available upon special request.

#### APPLICATION

Solder iron tip temperature should be between 350° - 400°C (650° - 750°F) for Sn63, Sn62 and Sn60 alloys, 370° - 425°C (700° - 800°F) for SN100C®, Sn/Ag and Sn/Ag/Cu (SAC305, SAC405, CASTIN, etc.) alloys.

#### CLEANING

Post-process residues can remain in place or be removed with commercially available flux removers. IPA is not recommended. Contact AIM for more detailed cleaning information.

#### STORAGE & SHELF LIFE

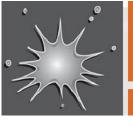
Store cored wire in a clean, dry area away from moisture and sunlight. Do not freeze this product.

Time	Temperature	
7 Years	< 85°F (< 29°C)	

#### **HEALTH & SAFETY**

Use with adequate ventilation and proper personal protective equipment. Refer to the accompanying Safety Data Sheet for any specific emergency information. Do not dispose of any hazardous materials in non-approved containers.

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#### TEST DATA SUMMARY

Name	Test Method	Results	
IPC Flux Classification	J-STD-004	ROL0	
IPC Flux Classification	J-STD-004B 3.3.1	ROL0	
Name	Test Method	Results	Image
Copper Mirror	J-STD-004B 3.4.1.1 IPC-TM-650 2.3.32	LOW	
Corrosion	J-STD-004B 3.4.1.2 IPC-TM-650 2.6.15	PASS	Before After
Quantitative Halides	J-STD-004B 3.4.1.3 IPC-TM-650 2.3.28.1	0.0%	
Qualitative Halides, Silver Chromate	J-STD-004B 3.5.1.1 IPC-TM-650 2.3.33	PASS	4
Qualitative Halides, Fluoride Spot	J-STD-004B 3.5.1.2 IPC-TM-650 2.3.35.1	No Fluoride	
Surface Insulation Resistance	J-STD-004 3.4.1.4 IPC-TM-650 2.6.3.3	PASS	13 12 (E11 0) 9 8 8 8 8 7 8 8 7 8 9 6 6
	J-STD-004B 3.4.1.4 IPC-TM-650 2.6.3.7	PASS	4 3 0 1 2 3 4 5 6 7  Time, day  RMA 2% Sn96/Ag4 1A RMA 2% Sn96/Ag4 1B RMA 2% Sn96/Ag4 1C RMA 2% Sn96/Ag4 1D RMA 2% Sn96/Ag4 2A RMA 2% Sn96/Ag4 2B RMA 2% Sn96/Ag4 2B RMA 2% Sn96/Ag4 2B RMA 2% Sn96/Ag4 3D Control 1A Control 1B Control 1D Control 2C Control 2D
Acid Value Determination	J-STD-004B 3.4.2.2 IPC-TM-650 2.3.13	159 ± 2 mgKOH/g flux Typical	

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